



#### **General Description**

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

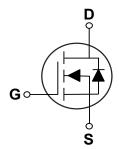
BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
650 V	120 mΩ	19.3 A

#### **Features**

- $R_{DS(ON)} \le 120 m\Omega@V_{GS} = \overline{10V}$
- · Improved dv/dt Capability
- · Fast Switching
- · Green Device Available

#### TO-220F Pin Configuration





#### **Applications**

- · LED Power Supply
- · Electronic Ballast
- High Frequency Switching Mode Power Supply

#### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted Rating **Symbol Parameter** Units $V_{DS}$ Drain-Source Voltage 650 V $V_{GS}$ Gate-Source Voltage ±30 V 19.3 $I_D$ Drain Current – Continuous (T<sub>C</sub>=25°C) Α $I_{DM}$ Drain Current - Pulsed (NOTE 1) 57.9 EAS Single Pulse Avalanche Energy (NOTE 2) 250 mJ $P_D$ 45 W Power Dissipation (T<sub>C</sub>=25°C) $T_J$ Operating Junction Temperature Range -55 to 150 ٥С Storage Temperature Range -55 to 150 $T_{STG}$ ٥С Marking Code NAB120

Thermal Characteristics					
Symbol	Parameter	Rating	Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	47.6	°C/W		
$R_{\theta JC}$	Thermal Resistance Junction to Case	2.78	°C/W		





#### Electrical Characteristics (T<sub>.J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	650			V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =650V , $V_{GS}$ =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±30V , $V_{DS}$ =0V			±100	nA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =15A			120	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	2.5		4.5	V
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =15A		20.9		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge			58		
$Q_gs$	Gate-Source Charge	$V_{DS}$ =520V , $V_{GS}$ =10V , $I_{D}$ =19A		19		nC
$Q_{gd}$	Gate-Drain Charge			19		
$T_{d(on)}$	Turn-On Delay Time			41		
T <sub>r</sub>	Rise Time	$V_{DD}$ =325V , $R_{G}$ =25 $\Omega$ , $I_{D}$ =19A , $V_{GS}$ =10V		75		nS
$T_{d(off)}$	Turn-Off Delay Time			165		113
$T_f$	Fall Time			68		
C <sub>iss</sub>	Input Capacitance			2598		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =100V , V <sub>GS</sub> =0V , F=1MHz		96		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			44		

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Body Diode Current				19.3	Α
I <sub>SM</sub>	Pulsed Diode Forward Current				57.9	Α
$V_{SD}$	Diode Forward Voltage	$V_{GS}$ =0V , $I_{S}$ =15A		-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>R</sub> =400V , I <sub>S</sub> =I <sub>F</sub> ,		365		nS
$Q_{rr}$	Reverse Recovery Charge	dI <sub>F</sub> /dt=100A/us		5.9		uC

#### NOTES:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2.  $I_{AS}\text{=}5A,\,V_{DD}\text{=}50V,\,R_{G}\text{=}25\Omega.$
- 3. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- $\label{eq:continuous} \textbf{4. Essentially independent of operating temperature}.$





#### **Characteristics Curves**

FIG. 1- Transfer Characteristics

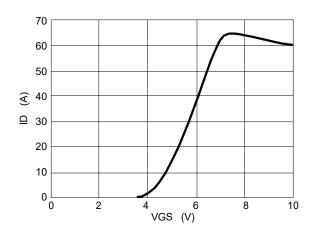


FIG. 2- R<sub>DS(ON)</sub> vs. I<sub>D</sub>

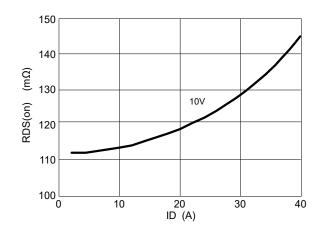


FIG. 3- $R_{DS(on)}$  (Normalized) vs.  $T_J$ 

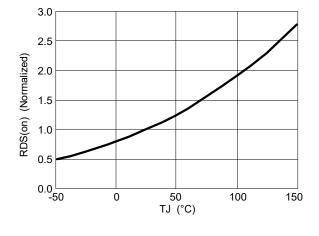


FIG. 4-BV<sub>DSS</sub> (Normalized) vs. T<sub>J</sub>

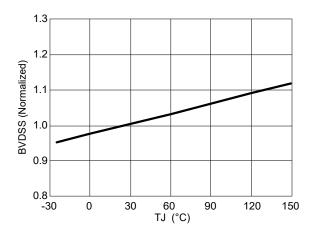


FIG. 5- Gate Charge Characteristics

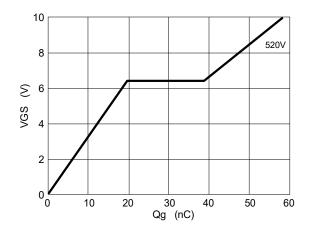
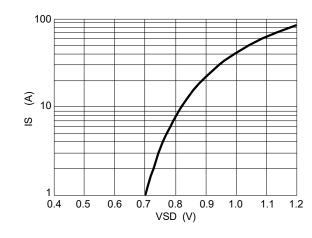


FIG. 6- Diode Forward Characteristics

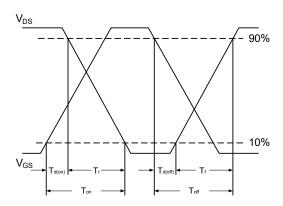




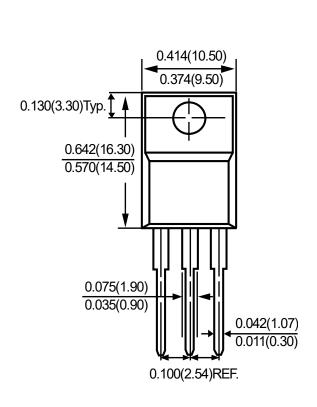


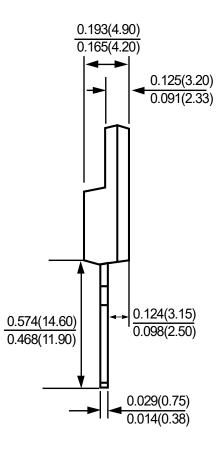
#### **Characteristics Curves**

FIG. 7- Switching Time Waveform



### **Package Outline Dimensions**





**TO-220F**Dimensions in inches and (millimeters)





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